Device

InGaAIN-Based Nitride TFTs

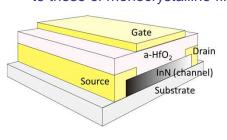
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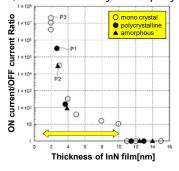
1. Abstract

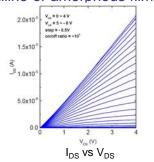
- A transistor having an InGaAIN-based nitride semiconductor layer as a channel is newly invented.
- Even though the film is polycrystalline or amorphous, electrical properties are equivalent to those of a monocrystalline film, in case they are designed in the range of suitable composition ratio of InGaAIN.

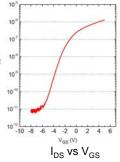
2. FET Having Thin Film of InN as a Channel

■ The InN-based nitride semiconductor layer is a polycrystalline or amorphous film having a film thickness of 1-10nm. The InN layer having a film thickness within the range exhibits electrical characteristics equivalent to those of monocrystalline film, even if the layer is polycrystalline or amorphous film.





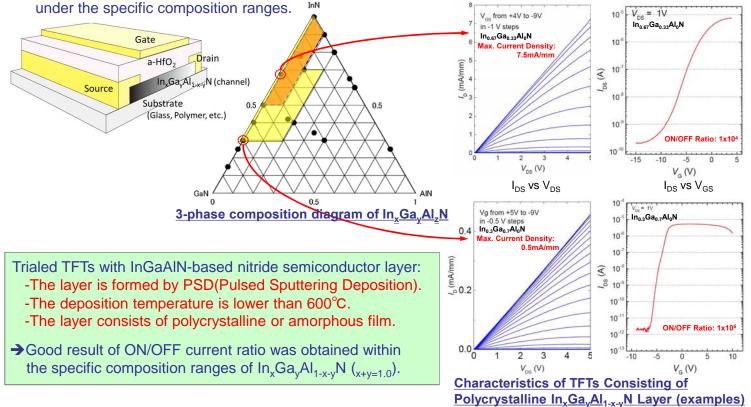




Characteristics of a TFT Consisting of Polycrystalline InN Layer

3. InGaAIN-based Nitride Semiconductor

■ We have found out that polycrystalline or amorphous InGaAlN-based nitride semiconductors, which consist of non-mono-crystalline films, have the same electrical characteristics as the case of a monocrystalline film



These results indicate:

- Constraints in manufacturing conditions are significantly resolved.
- Excellent electrical characteristics are provided at a reduced cost.

Patent Licensing Available

Patent: WO2015/029434, WO2015/029435

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